

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE ( $\pi$ -MOSIII)

## 2 S K 2 8 4 7

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS
DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

• Low Drain-Source ON Resistance :  $R_{DS(ON)} = 1.1\Omega$  (Typ.)

• High Forward Transfer Admittance :  $|Y_{fs}| = 7.0S$  (Typ.)

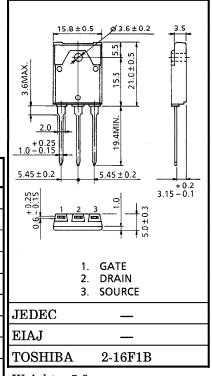
• Low Leakage Current : I<sub>DSS</sub>=100μA (Max.) (V<sub>DS</sub>=720V)

• Enhancement-Mode :  $V_{th} = 2.0 \sim 4.0 \text{V} \text{ (V}_{DS} = 10 \text{V}, I_D = 1 \text{mA)}$ 

### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{ m DSS}$	900	V
Drain-Gate Voltage (R <sub>GS</sub> =20kΩ)		$V_{ m DGR}$	900	V
Gate-Source Voltage	$v_{GSS}$	±30	V	
Drain Current	DC	$I_D$	8	Α
Drain Current	Pulse	$I_{\mathrm{DP}}$	24	Α
Drain Power Dissipation	$P_{\mathrm{D}}$	85	w	
Single Pulse Avalanche Energy**		EAS	799	mJ
Avalanche Current	$I_{AR}$	8	Α	
Repetitive Avalanche En	EAR	8.5	mJ	
Channel Temperature		${ m T_{ch}}$	150	$^{\circ}\mathrm{C}$
Storage Temperature Range		${ m T_{stg}}$	-55~150	$^{\circ}\mathrm{C}$

# INDUSTRIAL APPLICATIONS Unit in mm



Weight: 5.8g

#### THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	R <sub>th (ch-c)</sub>	1.47	°C/W
Thermal Resistance, Channel to Ambient	R <sub>th (ch-a)</sub>	41.6	°C/W

#### Note;

- \* Repetitive rating; Pulse Width Limited by Max. junction temperature.
- \*\*  $V_{DD}$ =90V,  $T_{ch}$ =25°C, L=22.9mH  $R_G$ =25 $\Omega$ ,  $I_{AR}$ =8A

THIS TRANSISTOR IS AN ELECTROSTATIC SENSITIVE DEVICE. PLEASE HANDLE WITH CAUTION.

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### ELECTRICAL CHARACTERISTICS (Ta = 25°C)

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CHARACT	ERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage C	urrent	$I_{ m GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0V$		_	±10	$\mu$ <b>A</b>
Gate-Source Breakdown Volt	age	V <sub>(BR)</sub> GSS	$I_{G} = \pm 10 \mu A, V_{DS} = 0 V$	±30	_	_	V
Drain Cut-off Cu	urrent	${ m I}_{ m DSS}$	$V_{DS}$ =720V, $V_{GS}$ =0V	_	_	100	$\mu$ A
Drain-Source Breakdown Volt	age	V <sub>(BR)</sub> DSS	$I_D=10$ mA, $V_{GS}=0$ V	900	_	_	V
Gate Threshold	Voltage	$ m v_{th}$	$V_{DS}=10V, I_{D}=1mA$	2.0	_	4.0	V
Drain-Source ON	N Resistance	R <sub>DS</sub> (ON)	$V_{GS}=10V, I_{D}=4A$	_	1.1	1.4	Ω
Forward Transfe	er Admittance	$ Y_{fs} $	$V_{DS}=15V, I_{D}=4A$	3.0	7.0		S
Input Capacitan	ce	$C_{iss}$		_	2040	_	
Reverse Transfer Capacitance		$\mathrm{C}_{\mathrm{rss}}$	$V_{ m DS}$ =25V, $V_{ m GS}$ =0V, $f$ =1MHz	_	45	_	pF
Output Capacitance		Cogg		_	190	_	
Switching Time	Rise Time	t <sub>r</sub>	$V_{GS} \stackrel{10V}{\underset{0V}{\bigvee}} \stackrel{I_{D}=4A}{\underset{V_{OUT}}{\bigvee}} V_{OUT}$ $\stackrel{4.7\Omega}{\underset{m}{\bigvee}} \stackrel{R_{L}}{\underset{=100\Omega}{\bigvee}} V_{DD} = 400V$		25	_	
	Turn-on Time	t <sub>on</sub>		_	60	_	na
	Fall Time	tf		_	20	_	ns
	Turn-off Time	<sup>t</sup> off	$egin{aligned}  extstyle V_{ extstyle IN}: t_{ extstyle r}, t_{ extstyle f} < 5  ext{ns}, \  ext{Duty} \leq 1\%, t_{ extstyle W} = 10 \mu  ext{s} \end{aligned}$	_	95	_	
Total Gate Charge (Gate-Source Plus Gate-Drain)		$\mathbf{Q}_{\mathbf{g}}$	  V <sub>DD</sub> ≒400V, V <sub>GS</sub> =10V,	_	58	_	0
Gate-Source Charge		$\mathbf{Q}_{\mathbf{g}\mathbf{s}}$	$I_{D}=8A$	_	32	_	nC
Gate-Drain ("Miller") Charge		$\mathbf{Q}_{\mathrm{gd}}$		_	26	_	

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{ m DR}$	_	_	_	8	A
Pulse Drain Reverse Current	$I_{ m DRP}$	<u> </u>		_	24	A
Diode Forward Voltage	$ m v_{DSF}$	$I_{DR}=8A, V_{GS}=0V$	1	_	-1.9	V
Reverse Recovery Time	t <sub>rr</sub>	$I_{DR}$ =8A, $V_{GS}$ =0V		1650	_	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_{ m DR}$ / $dt$ = 100A / $\mu$ s		21	_	μC

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